**3GPP TSG-RAN WG2 Meeting #121bis-e *R2-230xxxx***

**Electronic meeting, 17 – 26 April 2023**

**Agenda item: x.x**

**Source: Intel Corporation**

**Title: [Post121][654][IDC] Capability CRs on IDC (Intel)**

**Document for: Discussion and Decision**

# Introduction

This is the report of the following post meeting email discussion:

* [Post121][654][IDC] Capability CRs on IDC (Intel)

Scope: Capture decisions up to this meeting and to be endorsed as the baseline CRs

Intended outcome: Endorsable baseline CR

Deadline: Long

Two phases below are considered for this email discussion:

Phase 1: Discussion on the pre-requisite of the capabilities; Deadline: 28th March;

Phase 2: Review of proposals and draft CRs; Deadline: March 31st 12:00 UTC.

# Contact information

Respondents to the email discussion are kindly asked to fill in the following table.

|  |  |
| --- | --- |
| Company | Contact: Name (E-mail) |
| Intel | Yujian Zhang (yujian.zhang@intel.com) |
| Qualcomm | Sherif ElAzzouni (selazzou@qti.qualcomm.com) |
|  |  |
|  |  |
|  |  |
|  |  |
|  |  |

# Discussion

## Phase 1

In RAN2#121 meeting, following was agreed regarding IDC UE capabilities:

* Rel-18 IDC UE capability(ies) defined in NR side is/are per UE, not FDD-TDD DIFF, not FR1-FR2 DIFF.
* In NR side, 3 capability bit is introduced for FDM, periodic pattern and autonomous denial separately.
* The pre-requisite of autonomous denial is FDM solution (R16 or R18) or periodic pattern.

The main open issues are the pre-requisite of the capabilities.

Pre-requisite of Rel-18 IDC FDM solution

In [1], it is proposed that the pre-requisite of Rel-18 IDC FDM solution is Rel-16 NR IDC (*inDeviceCoexInd-r16*). An alternative is that no pre-requisite is defined for Rel-18 IDC FDM solution.

**Question 1:** Which option do you prefer for the pre-requisite of Rel-18 IDC FDM solution?

Option a: Rel-16 NR IDC (*inDeviceCoexInd-r16*);

Option b: Rel-18 IDC FDM solution does not have pre-requisite.

|  |  |  |
| --- | --- | --- |
| **Company** | **Option a/b** | **Comments** |
| Intel | Option a | Rel-18 IDC FDM solution provides finer granularity on top of Rel-16 reporting. |
| Qualcomm | Option a |  |
| vivo | Option a | If Rel-18 IDC FDM solution contains finer granularity based on Rel-16 NR IDC solution, the pre-requisite is needed. |
|  |  |  |
|  |  |  |
|  |  |  |
|  |  |  |
|  |  |  |

Pre-requisite of Rel-18 IDC periodic pattern

There are three options in contributions submitted to RAN2#121 meeting regarding the pre-requisite of Rel-18 IDC periodic pattern:

1) Rel-16 NR IDC (*inDeviceCoexInd-r16*), as from [1];

2) Rel-18 affected frequency indication in LTE for (NG)EN-DC operation or the Rel-18 IDC FDM solution in NR or *inDeviceCoexInd-ENDC-r15* or Rel-16 NR IDC *(inDeviceCoexInd-r16)*, as from [2];

3) Rel-18 IDC FDM solution in NR or Rel-16 NR IDC *(inDeviceCoexInd-r16)*, as from [3].

Given that RAN2 agreed that “*LTE MN does not configure the UE with R18 NR IDC configuration*”, it is rapporteur’s understanding that option 2) can be simplified to option 3). In addition, if Option a in Question 1 is agreed, then option 1) and 3) are also equivalent.

Therefore rapporteur proposes that the pre-requisite of Rel-18 IDC periodic pattern is Rel-18 IDC FDM solution or Rel-16 NR IDC(*inDeviceCoexInd-r16*), as in option 3 above. The pre-requisite can be further simplified to Rel-16 NR IDC(*inDeviceCoexInd-r16*) if Option a in Question 1 is agreed.

**Question 2:** Do you agree with the following? If not, please indicate preferred pre-requisite of Rel-18 IDC periodic pattern.

The pre-requisite of Rel-18 IDC periodic pattern is Rel-18 IDC FDM solution or Rel-16 NR IDC (*inDeviceCoexInd-r16*).

|  |  |  |
| --- | --- | --- |
| **Company** | **Agree / Disagree** | **Comments** |
| Intel | Agree |  |
| Qualcomm | Disagree | This is unneeded now that TDM has its own RRC configuration and the agreement that “3 capability bit is introduced for FDM, periodic pattern and autonomous denial separately.” . There is no need to include a frequency reporting pre-requisite. Recall that TDM can be used when FDM does not solve the problem, e.g., in NTN where the UE only operates in band n255. In this case, the UE does not need to support FDM capability (especially the high granularity FDM problem) as the problem can only be solved with TDM. |
| vivo | Disagree | Since we have agreed “3 capability bit is introduced for FDM, periodic pattern and autonomous denial separately.” the pre-requisite is unnecessary. |
|  |  |  |
|  |  |  |
|  |  |  |
|  |  |  |
|  |  |  |

# Conclusion

Based on the input from companies, we have the following proposals:

# References

[1] R2-2300833, Intel, “UE capabilities for IDC”

[2] R2-2301110, Xiaomi, “UE capability bits for IDC”

[3] R2-2301489, Huawei, HiSilicon, “Discussion on UE capability for IDC enhancement”